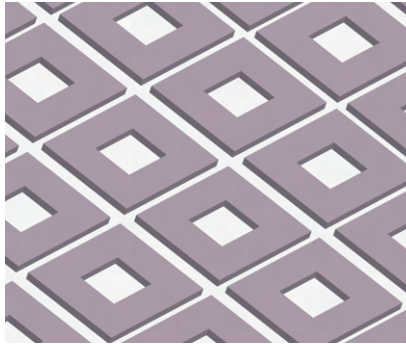


THER NAs-800-9-50

Patron
Passive Elektronik

Non-Silicone Thermal Conductive Pad

TYPICAL PROPERTIES



Non-Silicone Thermal Compound NAs-800 is made of non-silicon resin material. No low molecular siloxane volatilization and low total volatile gas, no electrical contact & pollution problems. NAs-800 is flexible and has great thermal conduction, Low com-pressive stress and high com-pressive characteristics can effectively reduce the stress load of components, so that the equipment only needs to bear less mechanical stress, and at the same time, it can have low thermal resistance and high thermal conductivity.

FEATURES

- / Thermal conductivity:9.0 W/m*K
- / It's made by non-silicone resin materials
- / Low contact thermal resistance
- / With electrical insulation
- / Outstanding thermal conductivity
- / Applicable to optical and

TYPICAL APPLICATION

- / HDDS
- / Optical appliance
- / 5G base station & infrastructure
- / EV electric vehicle

HOW TO ORDER

Patron THER NAs-800-9-50 XXX-YYY-ZZmm
XXX = width in mm
YYY = depth in mm
ZZ = thickness in mm

<https://www.patron-components.com/>

PROPERTY	NAs-800	TEST METHOD	UNIT
Color	Pink	Visual	-
Surface tack 2-side/1-side	2	-	-
Thickness	Customized	ASTM D374	mm
Density	3.4	ASTM D792	g/cm ³
Hardness	50	ASTM D2240	Shore OO
Tensile Strength	0.15	ASTM D412	Kgf/cm ²
Application temperature	-60~125	-	°C
Low molecular Siloxane (D3 to D20 total)	N.D	Gas Chromatography	%
Outgassing CVCN (wt%)	0.0049	-	-
ROHS & REACH	Compliant	-	-
COMPRESSION@1.0mm			
Deflection @10 psi	14	ASTM D5470 modify	%
Deflection @20 psi	35	ASTM D5470 modify	%
Deflection @30 psi	67	ASTM D5470 modify	%
ELECTRICAL			
Dielectric breakdown	8	ASTM D149	KV/mm
Surface resistivity	>10 ¹¹	ASTM D257	Ohm
Volume resistivity	>10 ¹⁰	ASTM D257	Ohm-m
THERMAL			
Thermal Conductivity	9.0	ASTM D5470	W/m*K
Thermal impedance@10 psi	0.238	ASTM D5470	°C-in ² / W
Thermal impedance@20 psi	0.166	ASTM D5470	°C-in ² / W
Thermal impedance@30 psi	0.102	ASTM D5470	°C-in ² / W

The chemical formula indicates that if Cyclic polydimethylsiloxane (HO-[Si(CH₃)₂O]_n-H) is non-reaction, it's volatile anytime and everywhere. For example, when the electric products which has been put in a confined space, the volatile of low-molecular-weight siloxanes will makes the electric products uncontacted.

Thermal Resistance vs. Pressure vs. Deflection

